

OVERVIEW OF MECHANICAL ENGINEERING RESEARCH

Auburn University

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OUTLINE

- Mechanical Engineering at Auburn University
 - Undergraduate and Graduate Programs
 - Faculty
 - Research Areas and Spotlights
 - Facilities
- Electronic Packaging Research
 - Material Testing
 - Silicon Sensors and Test Chips
 - Reliability Testing and Modeling







AUBURN ENGINEERING







AUBURN ENGINEERING

Enrollment

- 4100+ Undergraduate
- 850+ Graduate Students

Programs

- 13 Undergraduate Programs in 8 Departments
- Masters and Doctoral Degrees
- 140+ Faculty
- Ranked 28th Overall in the USA in Engineering









AUBURN ENGINEERING

Accreditation and Rankings

- ABET Accredited
- Ranked 28th Overall in the USA in Engineering







Department of Mechanical Engineering

UNDERGRADUATE PROGRAM

Auburn University Mechanical Engineering



ME Undergraduate Enrollment











PROGRAM SPOTLIGHT

Design and Manufacturing Laboratory



Department of Mechanical Engineering

UNIVERSITY

PROGRAM SPOTLIGHT

War Eagle Motorsports



Department of Mechanical Engineering

UNIVERSITY

NASA ROVER COMPETITION

MSFC, Huntsville, AL, April 2014







4th Place out of 46 Teams







GRADUATE PROGRAM

Auburn University Mechanical Engineering











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GRADUATE DEGREES

AU Mechanical Engineering

- Master of Science (M.S.) (Non-Thesis)
 - 30 Credit Hours of Course Work [1.0-2.0 Years]
- Master of Science (M.S.)
 - 24 Credit Hours of Course Work [1.0-1.5 Years]
 - 6 Credit Hours of Research Based Thesis [1.0-1.5 Years]
 - Funding from Graduate Assistantship [\$1000-\$2000 per month]
- Doctor of Philosophy (Ph.D.)
 - 30 Hours of Course Work [1.0-2.0 Years]
 - 30 Credit Hours of Research Based Dissertation [1.0-3.0 Years]
 - Funding from Graduate Assistantship [\$1000-\$2000 per month]



FACULTY

Department of Mechanical Engineering







Fergus

Mackowski





Jackson

Mishra



Cheng

Jones



Chin

Kang

Payton

Choe

Abdel-Hadi





Dyer

Crocker





Kim





Raju







Falkenberg

Simonian Roberts



Flowers

Madsen

Sinha

Harris



Marghitu





Suhling Thakur





Overfelt



Khodadadi

Prorok



Zee





FACILITIES

AU Mechanical Engineering

Wiggins Hall (Mechanical Engineering, and Woltosz Advanced Engineering Research Laboratories









AU Mechanical Engineering







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AU Mechanical Engineering

- Acoustics
- Advanced Powertrains
- Automotive Design
- Biohazard Detection
- Biomechanics
- Casting
- CFD
- Coatings and Thin Films
- Combustion
- Composite Materials
- Design of Machinery
- Dynamic Stability
- Electrical Connectors
- Electronics Cooling
- Electronic Packaging
- Electro-Optics
- Energy Harvesting Devices
- Energy Storage Devices
- Energy Sustainability
- Experimental Mechanics
- Finite Element Analysis
- Fluid Mechanics

- Flywheels
- Food Safety
- Fracture Mechanics
- Fuel Cells
- Gas Turbines
- GPS Guidance and Control
- Graded Materials
- Heat Pipes
- Heat Transfer
- HVAC
- Impact Dynamics
- Interferometry
- Magnetic Bearings
- Materials Processing
- MEMS
- Microfluidics/Nanofluidics
- Microscopy
- Motion Analysis
- Nanotechnology
- NDT/NDE
- Noise Control
- Nonlinear Optics

- Nonlinear Systems
- Optical Metrology
- Organic Semiconductors
- Prognostics (PHM)
- Radiation
- Robotic Welding
- Robotics
- Rotor Dynamics
- Sensors (Biological)
- Sensors (Chemical)
- Sensors (Magnetostrictive)
- Sensors (MEMS)
- Sensors (Piezoelectric)
- Sensors (Piezoresistive)
- Smart Materials
- Solar Energy
- Sound and Vibration
- Test Chips
- Thermal Systems
- Tribology
- Unmanned Vehicles (UAV)
- Vehicle Stability Control



AU Mechanical Engineering

ME Department 2014 Annual Research <u>Funding</u>: US\$ 6M <u>Publications</u>: 250

- <u>Research Thrusts</u>
 - Materials (Sensors, Bio/Nano, Detection and Food Safety)
 - Electronic Packaging (Reliability in Harsh Environments)
 - Vehicle Technology (Unmanned/Autonomous; Dynamics, Stability, and Controls; Advanced Powertrains: Fuel Cell and Hybrid)
- <u>Research Centers</u>
 - MREC (Materials Research and Education Center)
 - AUDFS (Auburn University Detection and Food Safety Center)
 - ACER (Air Cabin Environmental Research)
 - CAVE³ (Center for Advanced Vehicle and Extreme Environment Electronics)
- <u>Research Center in Development</u>
 - NSF STC on Next Generation Detection Technologies for Societal Health and Environment (Simonian, et al.)







RESEARCH SPOTLIGHT

AUDFS - Research in Biosensing of Pathogens and Food Safety





AUBURN

UNIVERSITY

RESEARCH SPOTLIGHT

Research on Autonomous Vehicles and Vehicle Dynamics/Control

David Bevly, Pl

\$15M Research over Past 10 Years Currently 26 Students (8 PhD, 14 MS, 4 BS)

Example Research Topics

- Unmanned Autonomous Vehicles
- Vehicle modeling
- Determination of rollover propensity
- Vehicle sensor fusion/integration
- GPS/INS navigation
- IMU & laser scanner fusion
- Sensor characterization and modeling
- Development of a software GPS receiver
- High speed control of ground vehicles

























RESEARCH SPOTLIGHT

CAVE³ - Center for Advanced Vehicle & Extreme Environment Electronics

- A National Science Foundation Industry/University Cooperative Research Center (I/UCRC)
- <u>Objective</u>: Research and Development (in Collaboration with Industry) on Electronic Packaging in Harsh Environments



- <u>Demographics</u>:
 - 20 Member Companies
 - 15 Faculty, 5 Staff
 - 35 Graduate Students
 - 10 Laboratories



<u>Director</u>: Pradeep Lall E-mail: <u>lallpra@auburn.edu</u>







RESEARCH OVERVIEW

Electronic Packaging

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ELECTRONIC PACKAGING

Example IPhone 6







ELECTRONIC PACKAGING

Example - Engine Controllers





Department of Mechanical Engineering

ME

ELECTRONIC PACKAGING

Examples from Auburn Stress Sensor Research







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Suhling Research Group

- Characterization and Modeling of the Mechanical ullet**Behavior of Microelectronic Packaging Materials**
 - Materials: Solders, Underfills, Mold Compounds, Adhesives, TIMs, Ceramics, PCBs, etc.
 - <u>Tests</u>: Stress-Strain (Tension/Compression/Shear) Creep, Poisson's Ratio, DMA, TMA, CTE, etc.
 - Constitutive Model Development
 - Aging Effects (Exposure to Temperature/Humidity)
- Silicon Piezoresistive Stress Sensors and Test Chips for Assembly and Reliability Studies
 - Sensor Theory and Calibration
 - Applications to Various Packaging Configurations

General Areas: Solid Mechanics Stress Analysis









Suhling Research Group

- Reliability Testing and Modeling
 - <u>Experimental</u>: Thermal Cycling, Thermal Shock, MSL/Humidity of Test Assemblies
 - <u>Modeling</u>: Finite Element Predictions for Thermal Cycling and Mechanical Loading









Capabilities

Mechanical Testing (Small Specimens)















5 kN (1125 lb)

- Tension/Torsion
- Stress-Strain
- Creep
- Shear
- Fatigue
- Poisson's Ratio
- DMA, TMA, DSC



Nanoindentation

10 x 1 x 0.5 mm



Environmental Testing

Thermal Cycling and Thermal Shock



• Temperature, Humidity, Vibration





Capabilities

Advanced Electronic Packaging



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Silicon Sensors

Sensor

Calibration



MICROSOFT APPLICATION

Polycarbonate Material in Kinect Camera Housing







MICROTESTER

Small Scale Mechanical Testing System

Stress-Strain Testing







Temperature Range: -190 to +300 C



POLYCARBONATE

Typical Specimen Deformations (T = 20 C)



EFFECTS OF AGING

Polycarbonate Stress-Strain Curves (T = 60 C)



SOLDER APPLICATION

Measurement of Material Properties





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NANOINDENTATION

Characterize Aging Effects in Actual Solder Joints

10 x 1 x 0.5 mm





SAMUEL GINN College of Engineering

SUMMARY DEPARTMENT OF MECHANICAL ENGINEERING

OLL INITEDECTO

ABOUT US

		• OUR RESEARCH INTERESTS	
 Two Acade Materials 27 Full Tin 	emic Programs: Mechanical Engineering and Engineering ne Tenure Track Faculty	 Materials (Sensors, Bio/Nano, Detection and Food Safety, Air Quality) 	
– 1219 Und – 169 Gradu	 1219 Undergraduate Students (Fall 2014) 169 Graduate Students (Fall 2014) 	 Electronic Packaging (Electronics Reliability in Harsh Environments, MEMS) 	
 >12,000 S 139Under 41 Gradua \$8.2M An [\$5-\$10M Ranked in 254 Public Conference 	tudent Credit Hours per Year (2009-2012) graduate Degrees (2013-14) ate Degrees (2013-14): 31 MS, 10 PhD nual Research Funding (2009-10) per Year in Each of Past 12 Years] Top 25 ME Programs by Funding Level cations (2013): 3 Books, 83 Journal Articles, 168 ce Papers	 Vehicle Technology (Unmanned/Autonomous; Dynamics, Stability, and Controls; Advanced Powertrains: Fuel Cell and Hybrid) Other Areas (Nanotechnology, Renewable Energy, Fracture Mechanics, Energy Sustainability, Motion Analysis, Fuel Cells, Prognostics/PHM, Acoustics, Nonlinear Optics, Biomechanics, and Many Others) 	
 PROGRAM Rigorous C (Incoming Nationally (Baja SAE, Successful Excellence Publication Extremely National R Excellent F Research L 	A HIGHLIGHTS Aurricula, Hard Working and Talented Students Student Average ACT was 28.3, Fall 2011) Competitive Undergraduate Student Design Teams Formula SAE, Solar Car, Lunar Rover, etc.) Alumni, Annual Alumni Conference in Scholarship: Research, Graduate Education, hs: Books, Chapters, Journal and Conference Articles, Active in Professional Societies and Activities ecognized Outreach Efforts: LITEE, GOP, AETAP facilities: Wiggins Hall (2012), Advanced Engineering aboratories (2012), Wilmore Hall (2004)	 OUR UNIQUE CAPABILITIES <u>Research Centers</u> — MREC (Materials Research and Education Center) — AUDFS (Auburn University Detection and Food Safety Center, AU Peak of Excellence) — ACER (FAA Center for Air Cabin Environmental Research) — CAVE³ (NSF Center for Advanced Vehicle and Extreme Environment Electronics)	

